Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!

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Technical Data Sheet

1.5mm Side Face Infrared LED

IR908-7C-F

Features

- High reliability
- High radiant intensity
- Peak wavelength λp=940nm
- 2.54mm Lead spacing
- Low forward voltage
- Pb free
- This product itself will remain within RoHS compliant version.

Descriptions

- EVERLIGHT's Infrared Emitting Diode (IR908-7C-F) is a high intensity diode , molded in a water clear plastic package.
- The miniature side- facing device has a chip , that emits radiation from the side of the clear package.

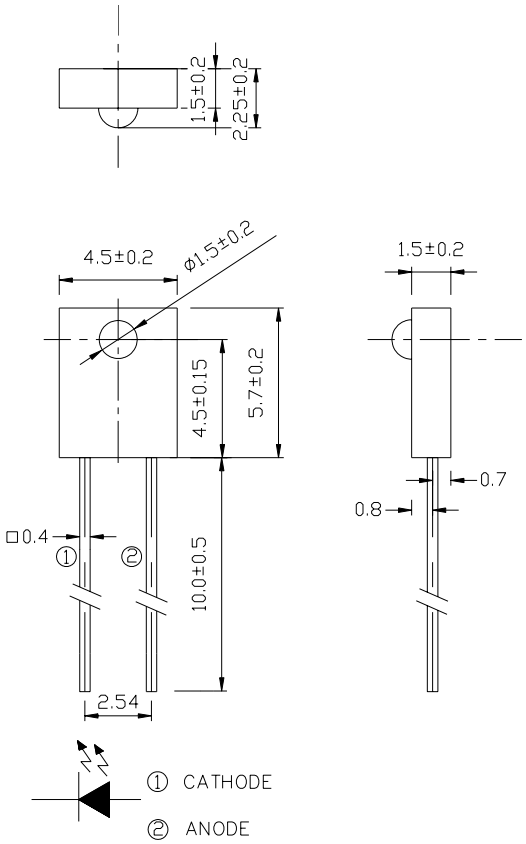
Applications

- Mouse
- Optoelectronic switch
- Infrared applied system

Device Selection Guide

LED Part No.	Chip Material	Lens Color
IR908-7C-F	GaAlAs	Water clear

Package Dimensions



Notes: 1.All dimensions are in millimeters
2.Tolerances unless dimensions ±0.25mm

Absolute Maximum Ratings (Ta=25℃)

Parameter	Symbol	Rating	Units
Continuous Forward Current	I_F	50	mA
Peak Forward Current	I_{FP}	1.0	A
Reverse Voltage	V_R	5	V
Operating Temperature	T_{opr}	-25 ~ +85	℃
Storage Temperature	T_{stg}	-40 ~ +85	℃
Soldering Temperature	T_{sol}	260	℃
Power Dissipation at(or below) 25℃ Free Air Temperature	P_d	75	mW

Notes: *1:I_{FP} Conditions--Pulse Width≦100 μs and Duty≦1%.
*2:Soldering time≦5 seconds.

Electro-Optical Characteristics (Ta=25℃)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Units
Light Current	Ic(on)	I_F=4mA,V_{CE}=3.5V	143	--	1274	μA
Peak Wavelength	λp	I_F=20mA	--	940	--	nm
Spectral Bandwidth	Δλ	I_F=20mA	--	45	--	nm
Forward Voltage	V_F	I_F=20mA		1.2	1.5	V
Reverse Current	I_R	V_R=5V	--	--	10	μA
View Angle	2θ1/2	I_F=20mA	--	60	--	deg

Rank

Color Code	Ranks	Symbol	Min	Typ	Max	Unit	Test Condition
Red	E1	Ic(on)	143	---	255	μA	I_F=4mA,V_{CE}=3.5V
Blue	E2	Ic(on)	214	---	343	μA	I_F=4mA,V_{CE}=3.5V
Yellow	E3	Ic(on)	286	---	431	μA	I_F=4mA,V_{CE}=3.5V
Silver	E4	Ic(on)	357	---	519	μA	I_F=4mA,V_{CE}=3.5V
Green	E5	Ic(on)	428	---	608	μA	I_F=4mA,V_{CE}=3.5V
Purple	E6	Ic(on)	500	---	696	μA	I_F=4mA,V_{CE}=3.5V
White	E7	Ic(on)	571	---	784	μA	I_F=4mA,V_{CE}=3.5V

Rough ranks

Parameter	Min	Max	Unit	Test Condition
7-2	306	441	μA	I_F=4mA,V_{CE}=3.5V
7-1	347	550	μA	I_F=4mA,V_{CE}=3.5V
6-2	465	750	μA	I_F=4mA,V_{CE}=3.5V
6-1	650	1274	μA	I_F=4mA,V_{CE}=3.5V

Typical Electro-Optical Characteristics Curves

Fig.1 Forward Current vs. Ambient Temperature

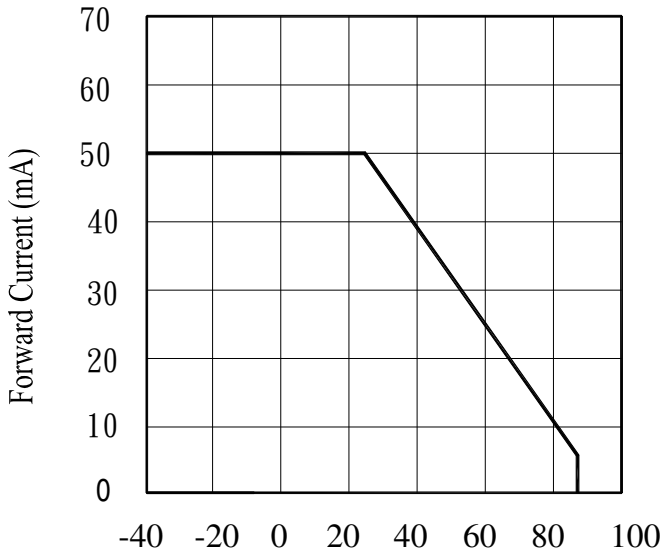


Fig.2 Spectral Distribution

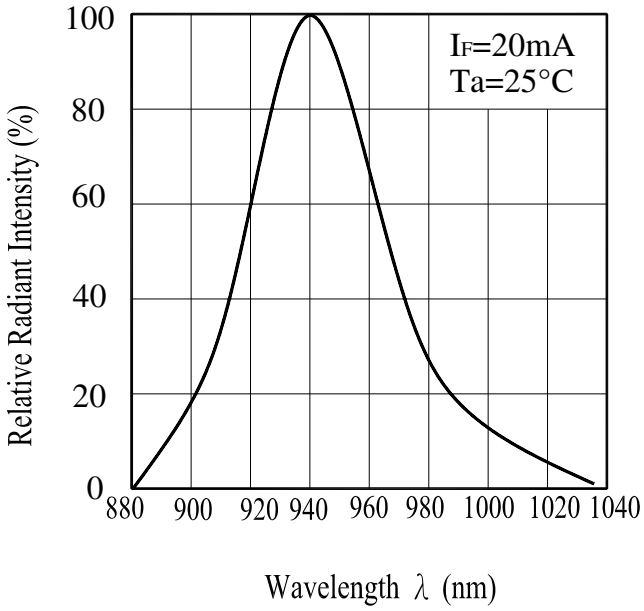


Fig.3 Peak Emission Wavelength Ambient Temperature

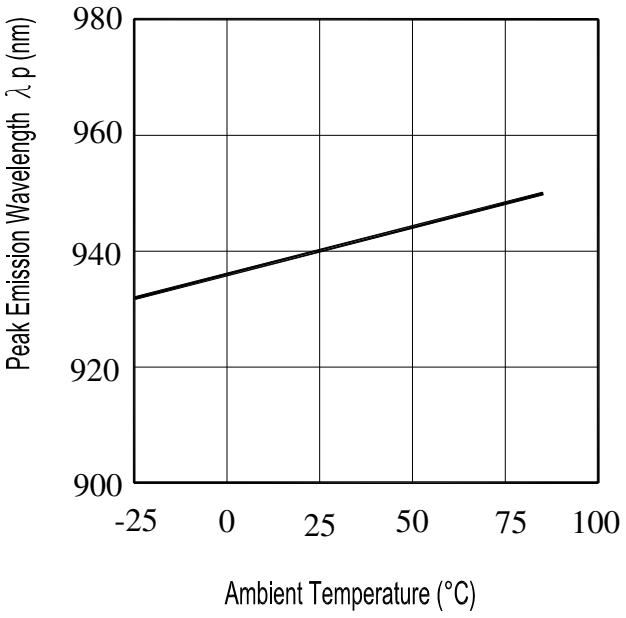
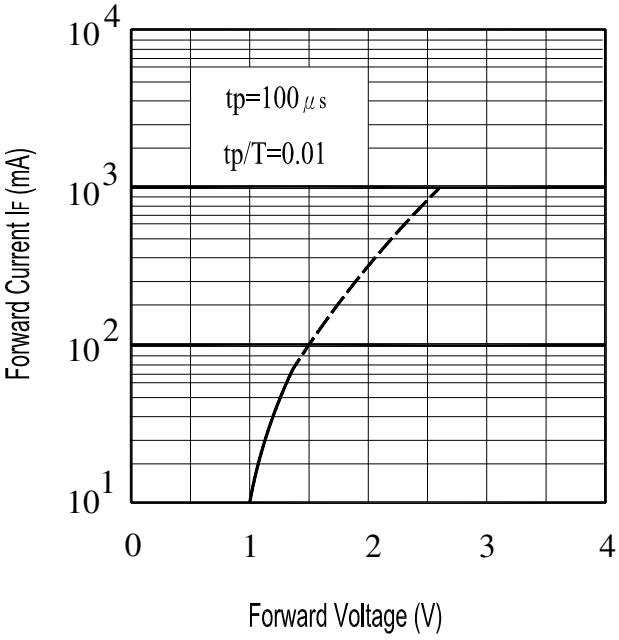


Fig.4 Forward Current vs. Forward Voltage



Typical Electro-Optical Characteristics Curves

Fig.8 Forward Current vs. Ambient Temperature(°C)

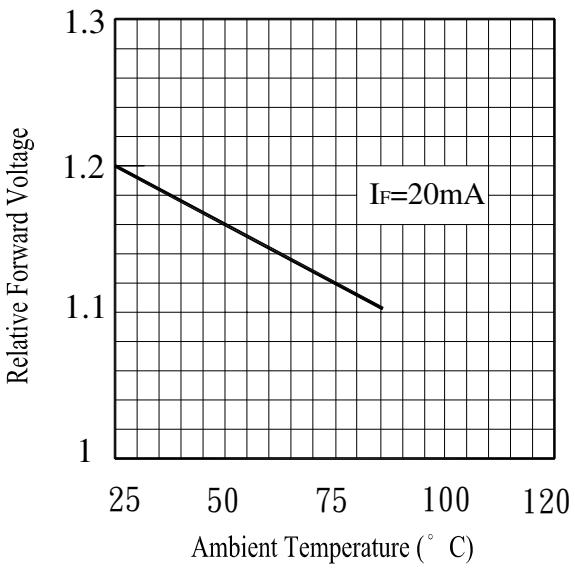
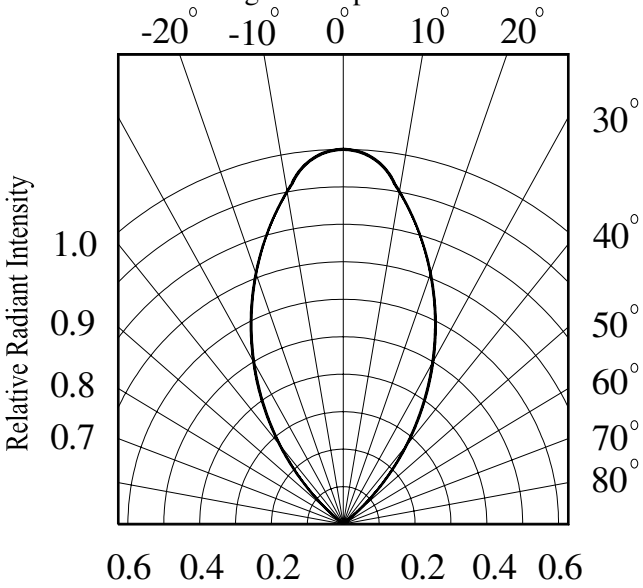


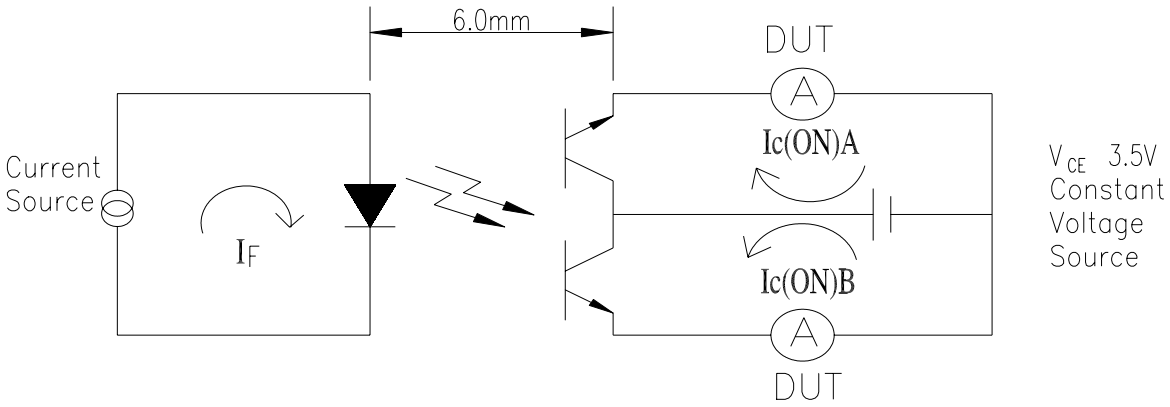
Fig.6 Relative Radiant Intensity vs. Angular Displacement



■ Test Method For $I_{C(ON)}$:

Condition: I_F=4mA,V_{CE}=3.5V

The intensity testing method for infrared emitting diode



Reliability Test Item And Condition

The reliability of products shall be satisfied with items listed below.

Confidence level：90%

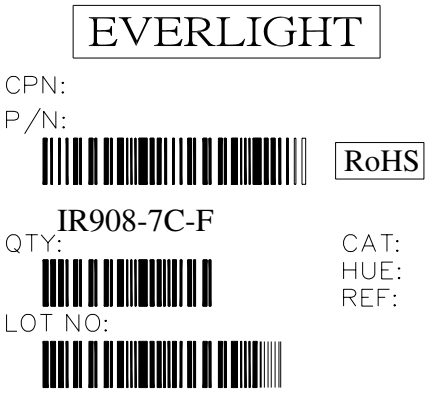
LTPD：10%

NO.	Item	Test Conditions	Test Hours/ Cycles	Sample Sizes	Failure Judgement Criteria	Ac/Re
1	Solder Heat	TEMP.：260℃±5℃	10secs	22pcs	Ee≦Lx0.8 V_F≦U U：Upper Specification Limit L：the initial test value	0/1
2	Temperature Cycle	H : +100℃ 15mins ↕ 5mins L : -40℃ 15mins	300Cycles	22pcs		0/1
3	Thermal Shock	H :+100℃ 5mins ↕ 10secs L :-10℃ 5mins	300Cycles	22pcs		0/1
4	High Temperature Storage	TEMP.：+100℃	1000hrs	22pcs		0/1
5	Low Temperature Storage	TEMP.：-40℃	1000hrs	22pcs		0/1
6	DC Operating Life	I_F=20mA	1000hrs	22pcs		0/1
7	High Temperature/ High Humidity	85℃ / 85% R.H	1000hrs	22pcs		0/1

Packing Quantity Specification

1. 1000PCS/1Bag,10Bag/1Box
2. 10Boxes/1Carton

Label Form Specification



CPN: Customer's Production Number
P/N : Production Number
QTY: Packing Quantity
CAT: Ranks
HUE: Peak Wavelength
REF: Reference
LOT No: Lot Number

Notes

1. Above specification may be changed without notice. EVERLIGHT will reserve authority on material change for above specification.
2. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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